/ Revised record

!"#" $%$&%$%' '
( ) *+,- silicon NPN and PNP transistor in a SOT-363 Plastic Package

'

With built-in bias resistors, simplify circuit design, reduce a quantity of parts and manufacturing process, Halogen-free Product.

/ Electrical Characteristic Curve(PNP)

S z ů d

/ Marking Instructions

H313***

● “1”

H313

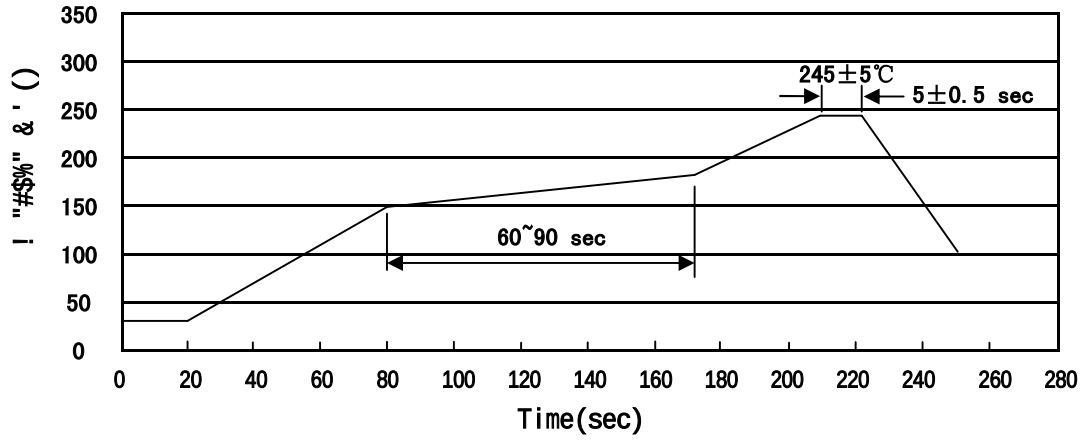
***:

Note:

● “1” Pin

H313	Product Type Code
***:	Lot No. Code, code change with Lot No.

( ) / Temperature Profile for IR Reflow Soldering(Pb-Free)



					Note:	
1		150	180	60 90sec;	1.Preheating:150~180℃, Time:60~90sec.	
2		245±5		5±0.5sec;	2.Peak Temp.:245±5℃, Duration:5±0.5sec.	
3			2	10℃/sec.	3. Cooling Speed: 2~10℃/sec.	

/ Resistance to Soldering Heat Test Conditions

260±5℃ 10±1 sec. Temp.:260±5 Time:10±1 sec

/ Packaging SPEC.

/ REEL

Package Type !	Units " # $					Dimension " % & (unit ' mm³)		
	Units/Reel 只/卷盘	Reels/Inner Box 卷盘/盒	Units/Inner Box 只/盒	Inner Boxes/Outer Box 盒/箱	Units/Outer Box 只/箱	Reel	Inner Box (	Outer Box)
SOT-363	3,000	10	30,000	6	180000	7″ ×8	180×120×180	390×385×205

/ Notices